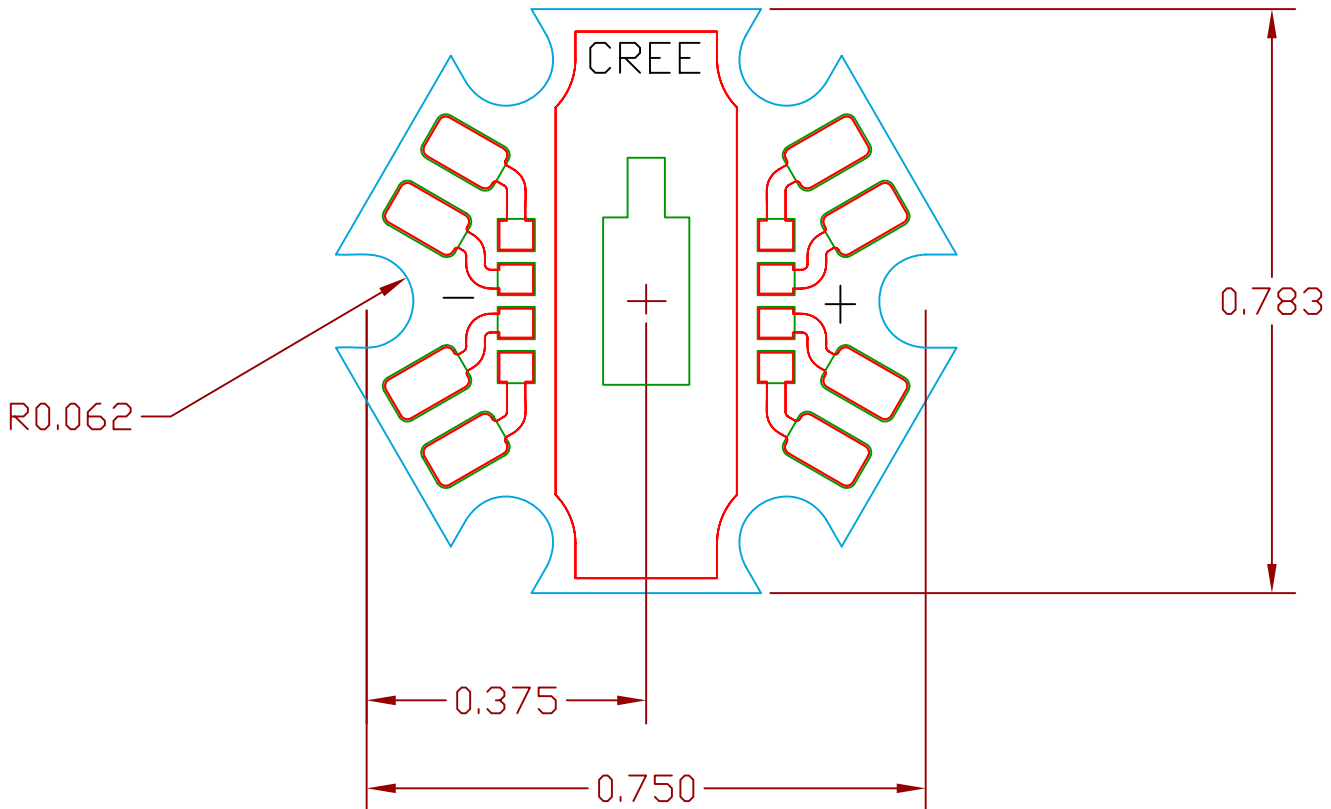
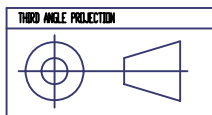


NOTICE  
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- NOTES:
1. Copper weight: 2-oz
  2. Dielectric Thickness: 0.004" MAX.
  3. Substrate:  
Material: 0.080" 6061-T6
  4. Holes: Drilled
  5. Solder Mask Type: LPI, Thickness: 0.0003", Color: White
  6. Pad Finish: Gold Plate



UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES & DECIMAL FRACTIONS TOLERANCES UNLESS SPECIFIED	JXX ± 0.01 JXXX ± .005 " ± .01
FOR SHEET METAL PARTS ONLY	JXX ± .02 JXXX ± .01 " ± .2

DRAWN BY R.Chaloupecky	DATE 05/12/07
CHECK	DATE
APPROVED	DATE
MATERIAL MCPCB (See Notes)	
FINAL PROTECTIVE FINISH	

		400 Silicon Drive Durham, NC 27709 Phone: 919 581-0770
<b>TITLE</b> MCPCB - STAR 7090MC INDIVIDUALLY ADDRESSABLE		
<b>SIZE</b> C	<b>DRAWING NO.</b> 2002-00020	<b>REV.</b> A
<b>SCALE</b> 4:1	<b>SHEET 1 OF 1</b>	